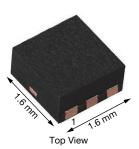
Vishay Siliconix

# P-Channel 30 V (D-S) MOSFET

### PowerPAK® SC-75-6L Single



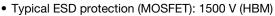


Marking code: BP

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	-30			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -10 V	0.065			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$	0.080			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -2.5 V	0.125			
Q <sub>g</sub> typ. (nC)	6.6			
I <sub>D</sub> (A) <sup>a</sup>	-4.5			
Configuration	Single			

#### **FEATURES**

- Thermally enhanced PowerPAK® SC-75 package
  - Small footprint area
  - Low on-resistance
  - Thin 0.75 mm profile



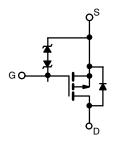


RoHS

- 100 % R<sub>q</sub> tested
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### **APPLICATIONS**

- Portable devices such as smart phones, tablet PCs, and mobile computing
  - Battery charger switch
  - Buck converter
  - Power management
  - Load switch



P-Channel MOSFET

ORDERING INFORMATION			
Package	PowerPAK SC-75		
Lead (Pb)-free and halogen-free	SiB4317EDK-T1-GE3		

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		$V_{DS}$	-30	.,,	
Gate-source voltage		$V_{GS}$	± 12	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-4.5 <sup>a</sup>		
	T <sub>C</sub> = 70 °C	1 . [	-4.5 <sup>a</sup>		
	T <sub>A</sub> = 25 °C	l <sub>D</sub>	-4.3 b, c		
	T <sub>A</sub> = 70 °C	1	-3.5 <sup>b, c</sup>	А	
Pulsed drain current (t = 300 μs)		I <sub>DM</sub>	-15		
Continuous source-drain diode current (MOSFET diode conduction)	T <sub>C</sub> = 25 °C	,	-4.5 <sup>a</sup>		
	T <sub>A</sub> = 25 °C	- I <sub>S</sub>	-1.63 <sup>b, c</sup>		
Maximum power dissipation	T <sub>C</sub> = 25 °C		10		
	T <sub>C</sub> = 70 °C	] [	6.4	w	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.95 <sup>b, c</sup>	- vv	
	T <sub>A</sub> = 70 °C		1.25 <sup>b, c</sup>	1	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	- °C	
Soldering recommendations (peak temperature) d, e			260		

#### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

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THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, b	t ≤ 5 s	$R_{thJA}$	51	64	°C/W	
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	10	12.5	C/VV	

#### Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. Maximum under steady state conditions is 100 °C/W

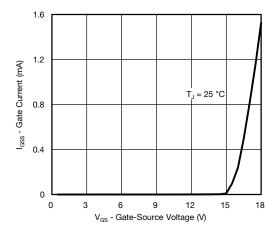
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	•		•		•		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$		-	-23	-	1400	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	2.7	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	-0.6	-	-1.3	V	
Gate-source leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$	-	-	± 0.5	μΑ	
	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$	-	-	± 10		
		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1		
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$	-	-	-10		
Drain-source on-state resistance <sup>a</sup>		$V_{GS} = -10 \text{ V}, I_D = -3 \text{ A}$	-	0.054	0.065	Ω	
	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -2 \text{ A}$	-	0.065	0.080		
		$V_{GS} = -2.5 \text{ V}, I_D = -1 \text{ A}$	-	0.095	0.125		
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -10 \text{ V}, I_D = -3 \text{ A}$	-	9	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	600	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	55	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	50	-		
		$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -4.2 \text{ A}$	-	14	23	nC	
Total gate charge	$Q_g$		-	6.6	10		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -4.2 \text{ A}$	-	1.3	-		
Gate-drain charge	Q <sub>gd</sub>		-	2	-	1	
Gate resistance	R <sub>q</sub>	f = 1 MHz	1.1	5.5	11	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	20	40	ns	
Rise time	t <sub>r</sub>	$V_{DD}$ = -15 V, $R_L$ = 4.4 $\Omega$	-	20	40		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -3.4 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	23	45		
Fall time	t <sub>f</sub>		-	10	20		
Turn-on delay time	t <sub>d(on)</sub>		-	10	20		
Rise time	t <sub>r</sub>	$V_{DD}$ = -15 V, $R_L$ = 4.4 $\Omega$	-	10	20		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -3.4 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	25	50		
Fall time	t <sub>f</sub>		-	7	15		
<b>Drain-Source Body Diode Characteris</b>	tics		•		•		
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-4.5	^	
Pulse diode forward current	I <sub>SM</sub>		-	-	-15	A	
Body diode voltage	V <sub>SD</sub>	$I_S = -3.4 \text{ A}, V_{GS} = 0 \text{ V}$	-	-0.9	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	16	30	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = -3.4 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$	-	8	15	nC	
Reverse recovery fall time	t <sub>a</sub>	T <sub>J</sub> = 25 °C	-	9	-	ns	
Reverse recovery rise time	t <sub>b</sub>		-	7	_		

#### Notes

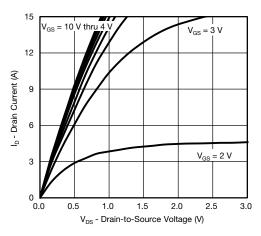
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

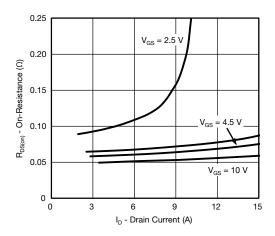




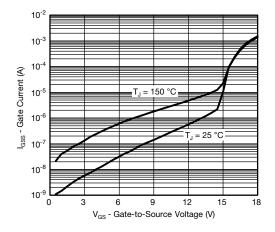
**Gate-Source Voltage vs. Gate Current** 



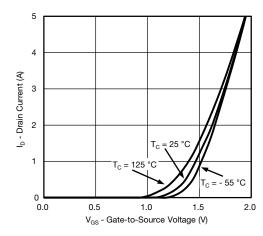
**Output Characteristics** 



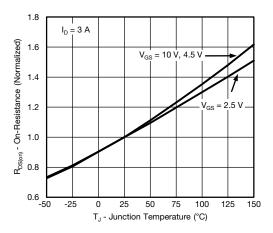
On-Resistance vs. Drain Current and Gate Voltage



**Gate-Source Voltage vs. Gate Current** 

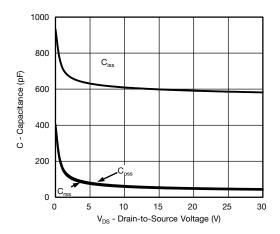


Transfer Characteristics

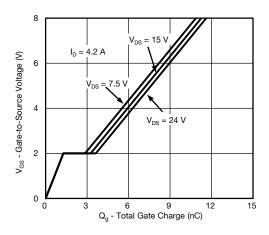


On-Resistance vs. Junction Temperature

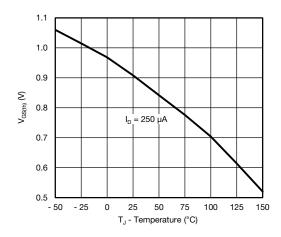




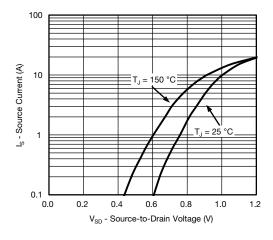
#### Capacitance



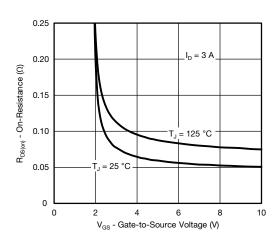
### **Gate Charge**



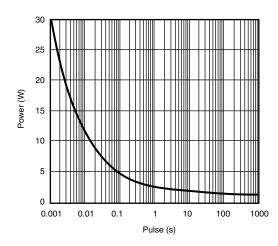
**Threshold Voltage** 



### Source-Drain Diode Forward Voltage

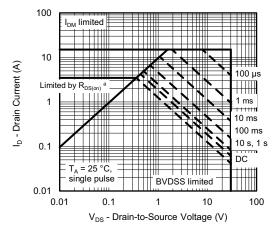


On-Resistance vs. Gate-to-Source Voltage

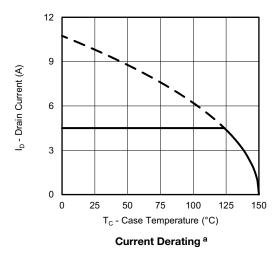


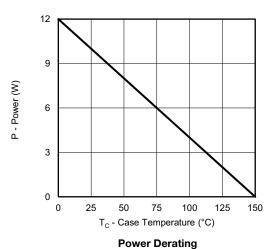
Single Pulse Power, Junction-to-Ambient





Safe Operating Area, Junction-to-Case

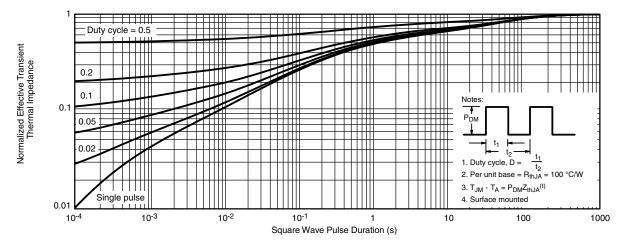




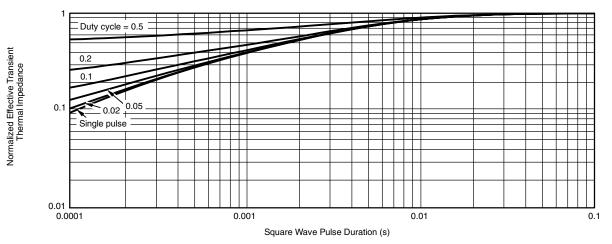
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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